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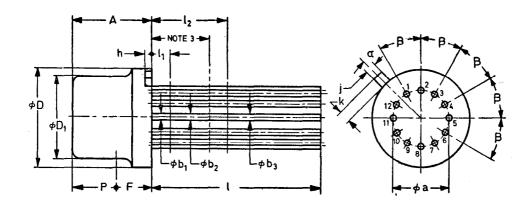


## Indian Standard

# DIMENSIONS OF SEMICONDUCTOR DEVICES DEVICE OUTLINE OD 27

#### 1. Dimensions

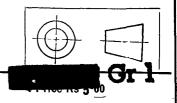
Note — This drawing has been prepared in accordance with IS:5001 (Part I) - 1969 'Guide for the preparation of drawings of semiconductor devices and integrated circuits: Part I Semiconductor devices' and IS:5001 (Part II)-1973 'Guide for the preparation of drawings of semiconductor devices and integrated circuits: Part II Integrated circuits'.



	Millimetres				
Reference	Mìn	Nom	Max	Degrees, Nom	Notes
A	6·10	_	6.60		
a	_	5.84*	_		1
b <sub>1</sub>	<del>-</del>		0.76		
<b>b</b> <sub>2</sub>	0.407	_	0.508	_	-
b <sub>3</sub>		_	0.53	_	
D	8:64	_	9.39	_	
D <sub>1</sub>	8:01		8.50	_	-
F	2.54	_	-	_	
h	0.15		1-00	_	-
j	0.712	0.787	0.863	_	
k	0.74	-	1:14		2

<sup>\*</sup>Means true geometrical position.

(Continued)



Adopted 8 December 1978

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## IS: 5000 (OD 27) - 1978

Reference	Millimetres				
	Min	Nom	Max	Degrees Nom	Notes
/1	_		1.27	<u> </u>	
/2	6.35	_	_	_	
1	12.7	_	_		
р	2.54	_		_	<del>-</del>
α			_	15 ± 3	
β	_		_	30*	1

Note 1 — The cross-section of each terminal at a distance of 1.37 mm from the seating plane lies in a circle having a diameter of 0.99 mm centred at the true geometrical position defining the terminal axis at its point of exit.

#### 2. Rules for Coding — See 8.1 of IS: 5001 (Part I)-1969.

#### 3. Equivalent Designation Code Followed by the Other Countries and Organizations

Country or Organization	Designation Code
India	OD27
IEC	_
United Kingdom	\$B 12-1
France	TO-73/F78 F79
Germany	5C12
USA	TO-73
Netherlands	NT-14/12
South Africa	TO-73

Note 2 — Measured from the actual diameter D of the device.

Note 3 — The minimum axial length from the seating plane beyond which the terminals may be bent at right angles is 3.8 mm.

Note 4 — One or more terminals may be omitted but the terminal position retains its number.